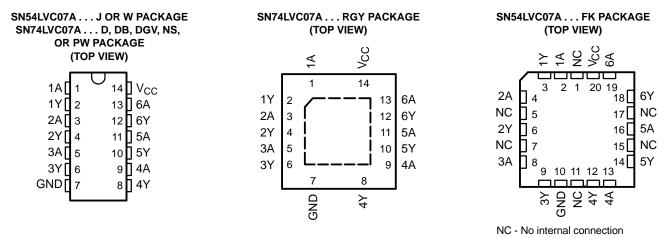


SCAS5950-OCTOBER 1997-REVISED JULY 2005

FEATURES

- Operate From 1.65 V to 5 V
- Inputs and Open-Drain Outputs Accept Voltages up to 5.5 V
- Max t_{pd} of 2.6 ns at 5 V
- Latch-Up Performance Exceeds 250 mA Per JESD 17



DESCRIPTION/ORDERING INFORMATION

These hex buffers/drivers are designed for 1.65-V to 5.5-V V_{CC} operation.

The outputs of the 'LVC07A devices are open drain and can be connected to other open-drain outputs to implement active-low wired-OR or active-high wired-AND functions. The maximum sink current is 24 mA.

Inputs can be driven from 1.8-V, 2.5-V, 3.3-V (LVTTL), or 5-V (CMOS) devices. This feature allows the use of these devices as translators in a mixed-system environment.

ORDERING INFORMATION

| T _A | PA | CKAGE ⁽¹⁾ | ORDERABLE PART NUMBER | TOP-SIDE MARKING | |
|----------------|-------------|----------------------|-----------------------|------------------|--|
| | QFN – RGY | Reel of 1000 | SN74LVC07ARGYR | LC07A | |
| | | Tube of 50 | SN74LVC07AD | | |
| | SOIC – D | Reel of 2500 | SN74LVC07ADR | LVC07A | |
| | | Reel of 250 | SN74LVC07ADT | | |
| 10°C to 95°C | SOP – NS | Reel of 2000 | SN74LVC07ANSR | LVC07A | |
| –40°C to 85°C | SSOP – DB | Reel of 2000 | SN74LVC07ADBR | LC07A | |
| | | Tube of 90 | SN74LVC07APW | LC07A | |
| | TSSOP – PW | Reel of 2000 | SN74LVC07APWR | | |
| | | Reel of 250 | SN74LVC07APWT | | |
| | TVSOP – DGV | Reel of 2000 | SN74LVC07ADGVR | LC07A | |
| | CDIP – J | Tube of 25 | SNJ54LVC07AJ | SNJ54LVC07AJ | |
| -55°C to 125°C | CFP – W | Tube of 150 | SNJ54LVC07AW | SNJ54LVC07AW | |
| | LCCC – FK | Tube of 55 | SNJ54LVC07AFK | SNJ54LVC07AFK | |

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

SCAS5950-OCTOBER 1997-REVISED JULY 2005



FUNCTION TABLE (EACH BUFFER/DRIVER)

| INPUT A | OUTPUT Y |
|------------|-------------|
| Н | Н |
| L | L |

LOGIC DIAGRAM, EACH BUFFER/DRIVER (POSITIVE LOGIC)



Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

| | | | MIN | MAX | UNIT |
|------------------|---|----------------------------|------|------|------|
| V _{CC} | Supply voltage range | | -0.5 | 6.5 | V |
| VI | Input voltage range ⁽²⁾ | | -0.5 | 6.5 | V |
| Vo | Output voltage range | | -0.5 | 6.5 | V |
| I _{IK} | Input clamp current | V ₁ < 0 | | -50 | mA |
| I _{OK} | Output clamp current | V _O < 0 | | -50 | mA |
| I _O | Continuous output current | · | | ±50 | mA |
| | Continuous current through V _{CC} or GND | | | ±100 | mA |
| | | D package ⁽³⁾ | | 86 | |
| | | DB package ⁽³⁾ | | 96 | |
| 0 | Dealer we the second increased | DGV package ⁽³⁾ | | 127 | 0000 |
| θ_{JA} | Package thermal impedance | NS package ⁽³⁾ | | 76 | °C/W |
| | | PW package ⁽³⁾ | | 113 | |
| | | RGY package ⁽⁴⁾ | | 47 | |
| T _{stg} | Storage temperature range | · · · · · | -65 | 150 | °C |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.
(3) The package thermal impedance is calculated in accordance with JESD 51-7.

(4) The package thermal impedance is calculated in accordance with JESD 51-5.

SCAS595O-OCTOBER 1997-REVISED JULY 2005

Recommended Operating Conditions⁽¹⁾

| | | | SN54LV | SN54LVC07A ⁽²⁾ | | VC07A | LINUT | |
|-----------------|--|--|----------------------|-----------------------------|----------------------|---------------------|-------|--|
| | | | MIN | MAX | MIN | MAX | UNIT | |
| V _{CC} | Supply voltage | | 1.65 | 5.5 | 1.65 | 5.5 | V | |
| | | V _{CC} = 1.65 V to 1.95 V | $0.65 \times V_{CC}$ | | $0.65 \times V_{CC}$ | | | |
| V | | V_{CC} = 2.3 V to 2.7 V | 1.7 | | 1.7 | | V | |
| VIH | High-level input voltage | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | 2 | | 2 | | V | |
| | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | $0.7 \times V_{CC}$ | | $0.7 	imes V_{CC}$ | | | | |
| | | V _{CC} = 1.65 V to 1.95 V | | $0.35 \times V_{\text{CC}}$ | | $0.35\times V_{CC}$ | | |
| | | V_{CC} = 2.3 V to 2.7 V | | 0.7 | | 0.7 | V | |
| V _{IL} | Low-level input voltage | $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$ | | 0.8 | | 0.8 | V | |
| | | $V_{CC} = 4.5 \text{ V to } 5.5 \text{ V}$ | | $0.3 	imes V_{CC}$ | | $0.3 	imes V_{CC}$ | | |
| VI | Input voltage | i. | 0 | 5.5 | 0 | 5.5 | V | |
| Vo | Output voltage | | 0 | 5.5 | 0 | 5.5 | V | |
| | | V _{CC} = 1.65 V | | 4 | | 4 | | |
| | | V _{CC} = 2.3 V | | 12 | | 12 | | |
| I _{OL} | Low-level output current | V _{CC} = 2.7 V | | 12 | | 12 | mA | |
| | | $V_{CC} = 3 V$ | | 24 | | 24 | | |
| | | V _{CC} = 4.5 V | | 24 | | 24 | | |
| T _A | Operating free-air temperature | · | -55 | 125 | -40 | 85 | °C | |

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Product preview (2)

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| DADAMETED | TEST CONDITIONS | V | SN54LVC07A ⁽¹⁾ | SN74LVC07A | UNIT | | | |
|------------------|---|-----------------|----------------------------|----------------------------|------|--|--|--|
| PARAMETER | TEST CONDITIONS | V _{cc} | MIN TYP ⁽²⁾ MAX | MIN TYP ⁽²⁾ MAX | | | | |
| | I _{OL} = 100 μA | 1.65 V to 5.5 V | 0.2 | 0.2 | | | | |
| | I _{OL} = 4 mA | 1.65 V | 0.45 | 0.45 | | | | |
| | 1. 12 | 2.3 V | 0.7 | 0.7 | V | | | |
| V _{OL} | I _{OL} = 12 mA | 2.7 V | 0.4 | 0.4 | V | | | |
| | 1 24 | 3 V | 0.55 | 0.55 | | | | |
| | $I_{OL} = 24 \text{ mA}$ | 4.5 V | | | | | | |
| l _l | $V_1 = 5.5 V \text{ or GND}$ | 3.6 V | ±5 | ±5 | μA | | | |
| I _{CC} | $V_{I} = V_{CC} \text{ or GND}, \qquad I_{O} = 0$ | 3.6 V | 10 | 10 | μA | | | |
| ΔI _{CC} | One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND | 2.7 V to 3.6 V | 500 | 500 | μΑ | | | |
| C _i | $V_{I} = V_{CC}$ or GND | 3.3 V | 5 | 5 | pF | | | |

(1)

Product preview All typical values are at V_{CC} = 3.3 V, T_A = 25^{\circ}C. (2)



SCAS5950-OCTOBER 1997-REVISED JULY 2005

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

| FROM TO V _{CC} = 1.8 V V _{CC} = 2.5 V V _{CC} = 3.3 V V _{CC} = 5 | | | | | | | | | | | | | |
|---|-----------------|----------------|----------------------------|-----|----------------------------|-----|-------------------|-------|----------------------------|--------------|---------------------------|-----|------|
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = ± 0.1 | | V _{CC} = ± 0.2 | | V _{CC} = | 2.7 V | V _{CC} = ± 0.3 | 3.3 V 3 V | = V _{CC} ± 0. | | UNIT |
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{pd} | А | Y | 1 | 3.5 | 1 | 2.8 | | 3 | 1 | 2.9 | 1 | 2.6 | ns |

(1) Product preview

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 1 through Figure 4)

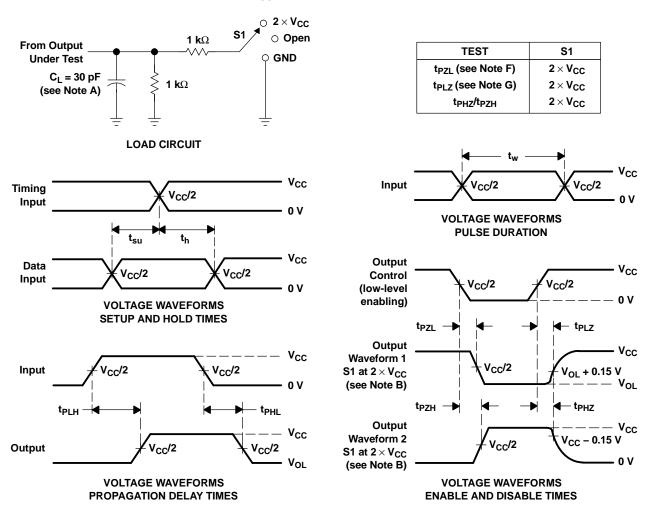
| | | | | SN74LVC07A | | | | | | | | | |
|-----------------|-----------------|----------------|----------------------------|------------|----------------------------|-----|-------------------|-------|----------------------------|-----|----------------------------|-----|------|
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | V _{CC} = ± 0.1 | | V _{CC} = ± 0.2 | | V _{CC} = | 2.7 V | V _{CC} = ± 0.3 | | = V _{CC} ± 0.5 | | UNIT |
| | | | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | MIN | MAX | |
| t _{pd} | А | Y | 1 | 3.5 | 1 | 2.8 | | 3 | 1 | 2.9 | 1 | 2.6 | ns |

Operating Characteristics

 $T_A = 25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | V _{CC} = 1.8 V TYP | V _{CC} = 2.5 V TYP | V _{CC} = 3.3 V TYP | V _{CC} = 5 V TYP | UNIT |
|-----------------|---|--------------------|--------------------------------|--------------------------------|--------------------------------|------------------------------|------|
| C _{pd} | Power dissipation capacitance per buffer/driver | f = 10 MHz | 1.8 | 2 | 2.5 | 3.78 | pF |

PARAMETER MEASUREMENT INFORMATION V_{cc} = 1.8 V \pm 0.15 V

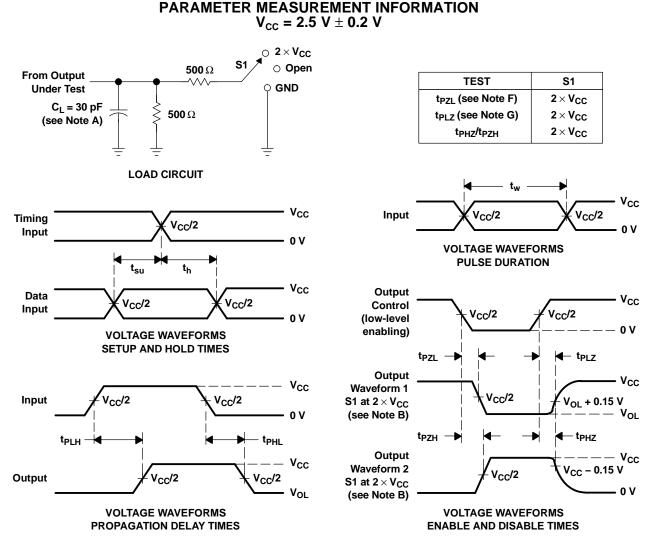


NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r \leq 2 ns, t_f \leq 2 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs, t_{PLZ} and t_{PZL} are the same as t_{od} .
- F. t_{PZL} is measured at $V_{CC}/2$.
- G. t_{PLZ} is measured at V_{OL} + 0.15 V.
- H. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

SCAS5950-OCTOBER 1997-REVISED JULY 2005



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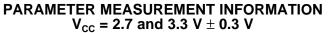
STRUMENTS www.ti.com

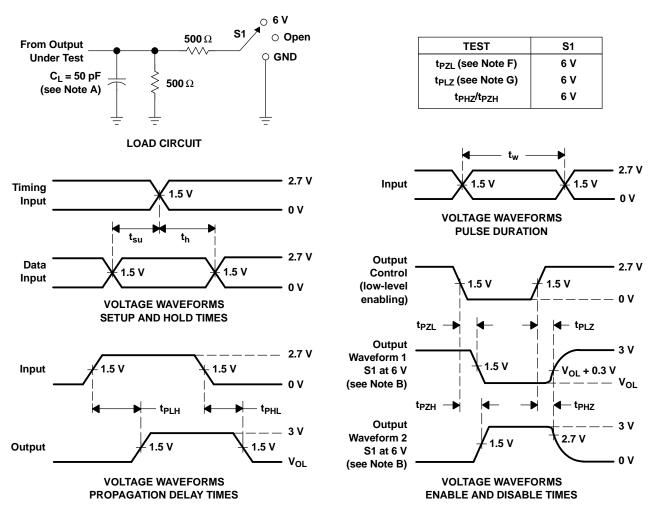
NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: $PRR \le 10$ MHz, $Z_0 = 50 \Omega$, $t_r \le 2$ ns, $t_f \le 2$ ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs, t_{PLZ} and t_{PZL} are the same as t_{pd} .
- F. t_{PZL} is measured at $V_{CC}/2$.
- G. t_{PLZ} is measured at V_{OL} + 0.15 V.
- H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

SCAS595O-OCTOBER 1997-REVISED JULY 2005



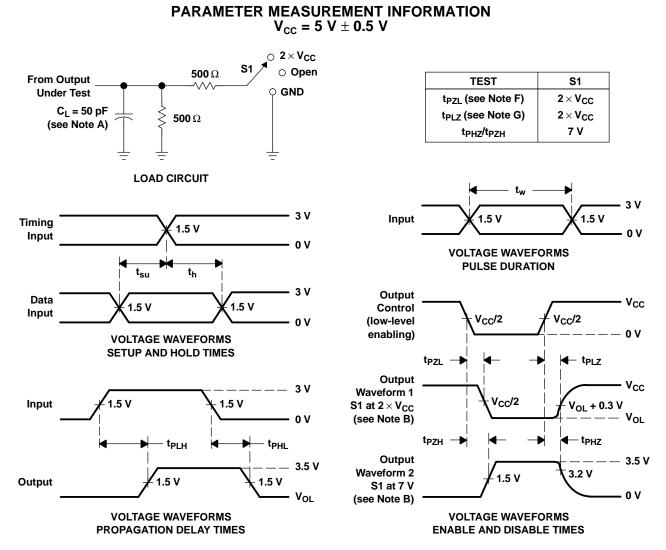


NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z₀ = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs, t_{PLZ} and t_{PZL} are the same as t_{pd} .
- F. t_{PZL} is measured at 1.5 V.
- G. t_{PLZ} is measured at V_{OL} + 0.3 V.
- H. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

SCAS595O-OCTOBER 1997-REVISED JULY 2005



7 Texas istruments

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NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control.
- Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω , t_r \leq 2.5 ns, t_f \leq 2.5 ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. Since this device has open-drain outputs, t_{PLZ} and t_{PZL} are the same as t_{pd} .
- F. t_{PZL} is measured at $V_{CC}/2$.
- G. t_{PLZ} is measured at V_{OL} + 0.3 V.
- H. All parameters and waveforms are not applicable to all devices.

Figure 4. Load Circuit and Voltage Waveforms

9-Aug-2005

PACKAGING INFORMATION

TEXAS STRUMENTS www.ti.com

Ĵ.

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| SN74LVC07AD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADBR | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADBRG4 | ACTIVE | SSOP | DB | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADGVR | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADGVRE4 | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADGVRG4 | ACTIVE | TVSOP | DGV | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADR | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADRE4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADRG4 | ACTIVE | SOIC | D | 14 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADT | ACTIVE | SOIC | D | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ADTE4 | ACTIVE | SOIC | D | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ANSR | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ANSRE4 | ACTIVE | SO | NS | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APW | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWE4 | ACTIVE | TSSOP | PW | 14 | 90 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWLE | OBSOLETE | TSSOP | PW | 14 | | TBD | Call TI | Call TI |
| SN74LVC07APWR | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWRE4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWRG4 | ACTIVE | TSSOP | PW | 14 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWT | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWTE4 | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07APWTG4 | ACTIVE | TSSOP | PW | 14 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74LVC07ARGYR | ACTIVE | QFN | RGY | 14 | 1000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-2-260C-1YEAR |

⁽¹⁾ The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.



LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

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⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



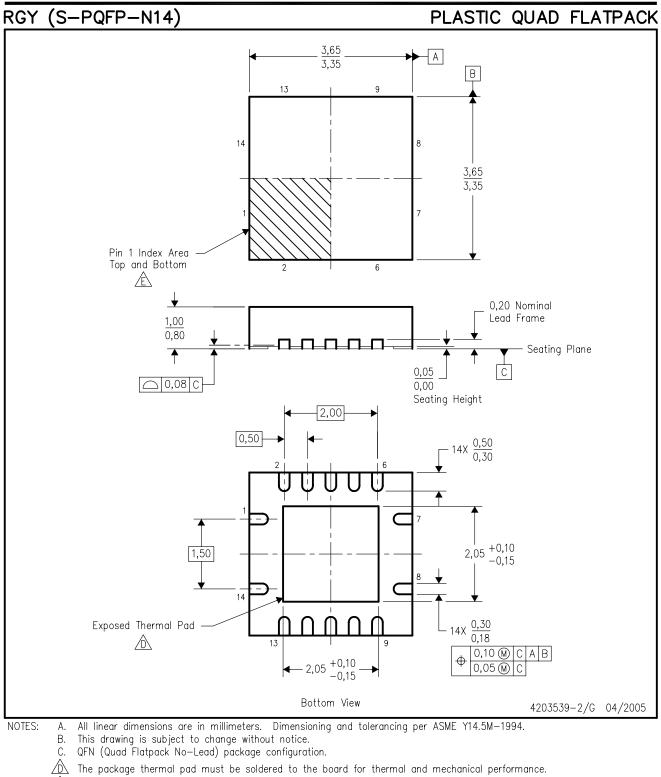
NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).

D. Falls within JEDEC MS-012 variation AB.





È Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.

F. Package complies to JEDEC MO-241 variation BA.



PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



MTSS001C - JANUARY 1995 - REVISED FEBRUARY 1999

PW (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-153



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Mailing Address:

Texas Instruments

Post Office Box 655303 Dallas, Texas 75265

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